



# Data Sheet

Customer:

Part No:

CL-SFC3030DBW-6.5K-B-02

Sample No:

Description:

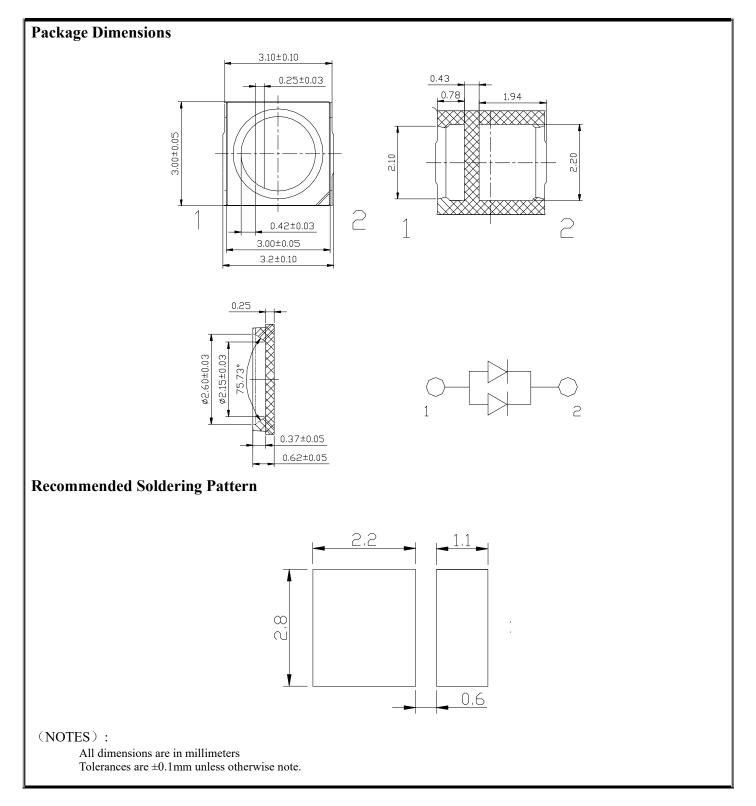
Item No:

3030 SMD WHITE Color

Customer					
Check	Inspection	Approval	Date		



## CL-SFC3030DBW-6.5K-B-02



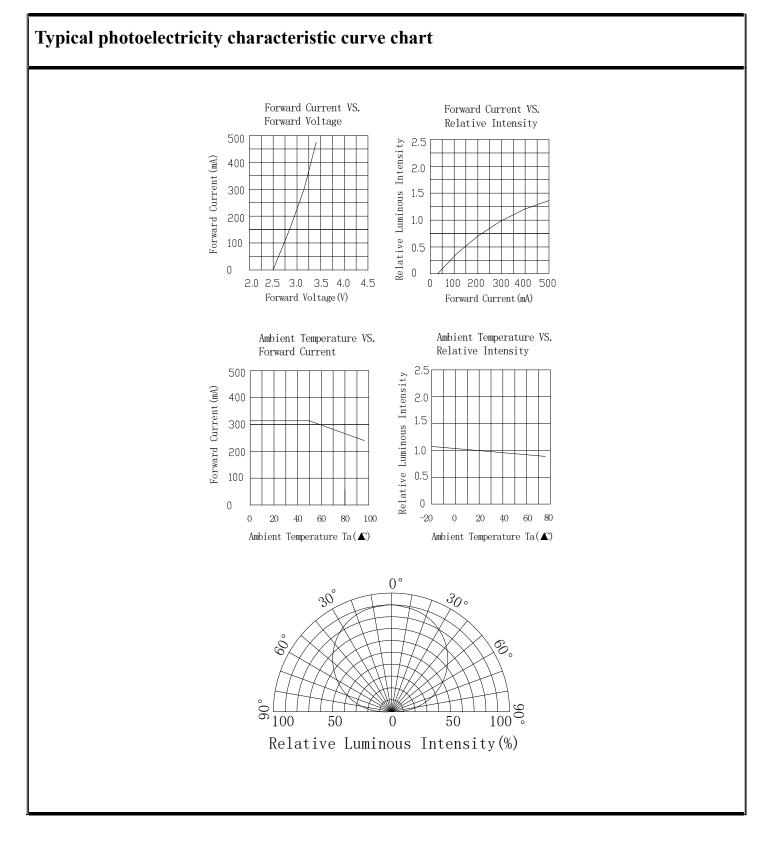




Absolute maximum r		(Ta=25°C)						
Parameter			Symbol		Value		Unit	
Forward current			If	If			mA	
Reverse voltage			Vr	Vr 5			V	
Power dissipation			Pd	Pd 960		mW		
Operating temperature range			Тор	Top -25~+80		°C		
Storage temperature range			Tstg	g -30~+85		;	°C	
Peak pulsing current (1/8 duty f=1KHz)			Ifp	500			mA	
Junction Temperature			Tj	Tj 115			°C	
Electrostatic Discharge(HBM)			ESD	D 2000			V	
Electro-Optical characteristics			(TA=25°C)					
Parameter	Test Condition Sym	Symbo	vmbol Color	Value		Unit		
		Symbo		Min	Тур	Max		
Color Temperature	IF=300mA	CCT	W	6000		7000	K	
Forward voltage	IF=300mA	Vf	W	3.0		3.4	V	
luminous flux	IF=300mA	φ	W	120		140	LM	
Viewing angle at 50% IV	IF=300mA	201/2	W		120		Deg	
Dominant wavelength	IF=300mA	λd	W				nm	
Reverse current	Vr=5V	Ir	W		5		μΑ	
Color Rendering Index	IF=300mA	CRI	W				Ra	



## CL-SFC3030DBW-6.5K-B-02





## CL-SFC3030DBW-6.5K-B-02

Test items and results of reliability						
Туре	Test item	Standard	Test Conditions	Note		
Environmental Sequence	Temperature Cycle	JIS C 7021 (1977)A-4	-25°C 30min ↑↓5min 80°C 30min	100 cycle	22	0
	Thermal Shock	MIL-SLD-107D	MIL-SLD-107D -25°C 15min   \$0°C 15min \$0°C 15min		22	0
	High Humidity Heat Cycle	JIS C 7021 (1977)A-5 $30^{\circ}C \langle = \rangle 65^{\circ}C \\ 90\%RH 24hrs/1 cycle$		10 cycle	22	0
	High Temperature Storage	JIS C 7021 (1977)B-10	T <sub>a</sub> =80°C	1000hrs	22	0
	Humidity Heat Storage	JIS C 7021 (1977)B-11	T <sub>a</sub> =60°C RH=90%	1000hrs	22	0
	Low Temperature Storage	JIS C 7021 (1977)B-12 $T_a = -30^{\circ}C$		1000hrs	22	0
Operation Sequence	Life Test	JIS C 7035 (1985) $T_a=25^{\circ}C$ I <sub>F</sub> =300mA		1000hrs	22	0
	High Humidity Heat Life Test	*	60°C RH=90% I <sub>F</sub> =300mA	500hrs	22	0
	Low Temperature Life Test	*	$Ta=-25^{\circ}C$ I <sub>F</sub> =300mA	1000hrs	22	0

**\*** Refer to reliability test standard specification for in this line.

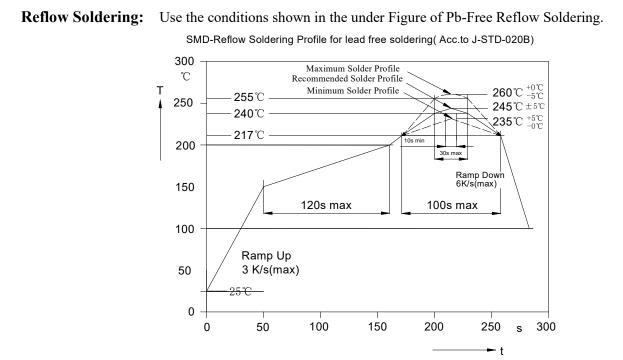
#### **Criteria For Judging Damage**

Test item	Symbol	Test Conditions	Standard
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =I <sub>FT</sub>	Initial Data±10%
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	I <sub>R</sub> ≦10µA
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =I <sub>FT</sub>	Average I <sub>V</sub> degradation $\leq 30\%$ Single LED I <sub>V</sub> degradation $\leq 50\%$
Resistance to Soldering Heat			Meterial without internal cracks, no material between stripped, no deaded light.

\*The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.



## **Guideline for Soldering**



**Remark:** If not lead free soldering, the recommended solder profile is 230°Cand max solder profile is 245°C.

#### 1、 Hand Soldering

1)、

A soldering iron of less than 20W is recommended to be used in Hand Soldering Please keep the temperature of the soldering iron under 360°C while soldering Each terminal of the LED is to go for less than 3 second and for onetime only.

#### 2)

Be careful because the damage of the product is often started at the time of the hand soldering.

#### 2、 Cleaning

1),

It is recommended that alcohol be used as a solvent for cleaning after soldering. Cleaning is to go under 30°C for 3 minutes or 50°C for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

#### 2),

Ultrasonic cleaning is also an effective way for cleaning. But the influence of Ultrasonic cleaning on LED depends on factors such an ultrasonic power. Generally, the ultrasonic power should not be higher than 300W.Before cleaning, a pre-test should be done to confirm whether any damage to LEDs will occur.





#### **Tape and Packaging** 1. Tape leader and reel 4.0 2.0 4.0 0.18 0 Ο Ο Ο 00 Ο 0 G 0 φ 0 0 0 0 0 85 **Moisture Resistant Packaging** 2 Lab le Desiccant Alum inum moisture-proofbag Lable

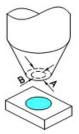
### 3、 Cautions

#### 1),

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.

#### 2)、

The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible. pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.





## CL-SFC3030DBW-5.7K-B-02

## **Handling Precautions**

1. Handle the component along the side surface by using forceps or appropriate tools; do not directly touch or Handle the

silicone lens surface, it may damage the internal circuitry.

